

# P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
- 60	$0.012 \text{ at V}_{GS} = -10 \text{ V}$	- 60 <sup>d</sup>		
	0.014 at V <sub>GS</sub> = - 4.5 V	- 55 <sup>d</sup>		

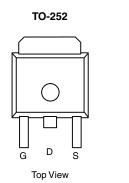
#### **FEATURES**

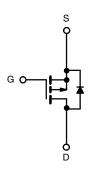
- DT-Trench Power MOSFET
- Material categorization:



#### **APPLICATIONS**

Load Switch





P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	-60	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain august (T. 175 °C)	T <sub>C</sub> = 25 °C	I <sub>D</sub>	-60 <sup>d</sup>		
Continuous drain current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 100 °C		-49		
Pulsed drain current		I <sub>DM</sub>	-240	А	
Avalanche current		I <sub>AR</sub>	-55		
Repetitive avalanche energy <sup>a</sup>	L = 0.1 mH	E <sub>AR</sub>	255	mJ	
Power dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	196 <sup>c</sup>	w	
rower dissipation	T <sub>C</sub> = 75 °C	] <sup>r</sup> D	119 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-ambient <sup>b</sup>	t ≤ 10 s	В	10	14	
Junction-to-ambient *	Steady state	R <sub>thJA</sub>	20	30	°C/W
Junction-to-case		R <sub>thJC</sub>	0.5	0.75	

#### Notes

- a. Duty cycle  $\leq 1\%$
- b. When mounted on 1" square PCB (FR4 material)
- c. See SOA curve for voltage derating
- d. Package limited 60A



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60	-	-	V	
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-3		
Gate-body leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current		V <sub>DS</sub> = -48 V, V <sub>GS</sub> = 0 V	-	-	-1		
	I <sub>DSS</sub>	V <sub>DS</sub> = -48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	-50	μΑ	
		V <sub>DS</sub> = -48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C	-	-	-150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ -5 V, V <sub>GS</sub> = -10 V	-60	-	-	Α	
Drain-source on-state resistance <sup>a</sup>	D	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -20 A	-	0.012	0.015	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -15 \text{ A}$	-	0.014	0.022		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -20 A	-	64	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = -30 V, f = 1 MHz	-	10250	-	pF	
Output capacitance	Coss		-	599	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	112	-		
Total gate charge <sup>c</sup>	$Q_g$		-	120	-	nC	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$	-	69	-		
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>		-	38	-		
Turn-on delay time c	t <sub>d(on)</sub>		-	18	-		
Rise time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -30 \text{ V}, \text{ R}_L = 0.6 \Omega$ $I_D \cong -20 \text{ A}, \text{ V}_{GEN} = -10 \text{ V}, \text{ R}_G = 6 \Omega$	-	71	-	ns	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>		-	125	-		
Fall time <sup>c</sup>	t <sub>f</sub>		-	135	-		
Source-Drain Diode Ratings and Ch	aracteristics (	T <sub>C</sub> = 25 °C) <sup>b</sup>		•			
Continuous current	I <sub>S</sub>		-	-	-60	Α	
Pulsed current	I <sub>SM</sub>	1		-	-240	_ A	
Forward voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = -20 A, V <sub>GS</sub> = 0 V	-	0.8	-	V	
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = -20 A, di/dt = 100 A/μs	_	45	_	ns	

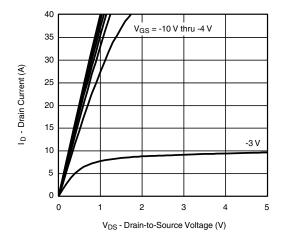
#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

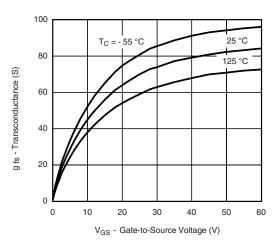
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



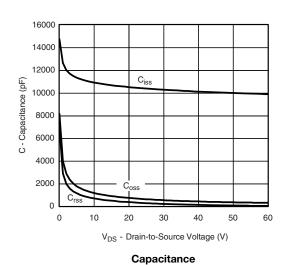
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

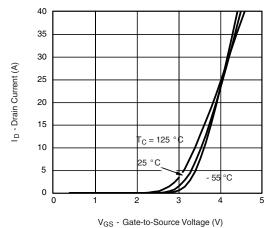


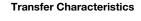
#### **Output Characteristics**

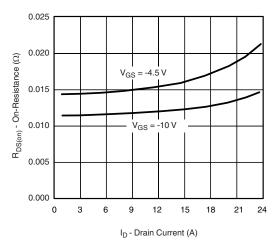


#### Transconductance

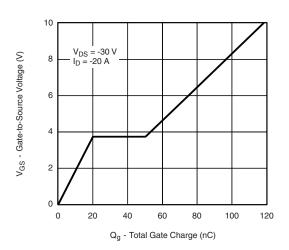








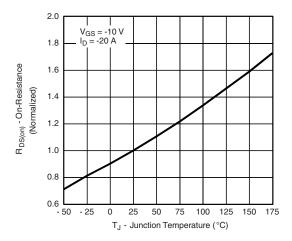
#### On-Resistance vs. Drain Current



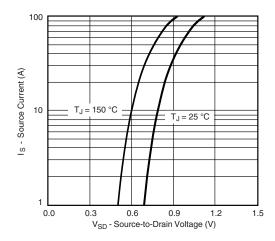
**Gate Charge** 



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

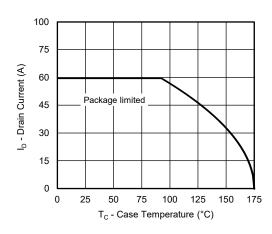


**On-Resistance vs. Junction Temperature** 

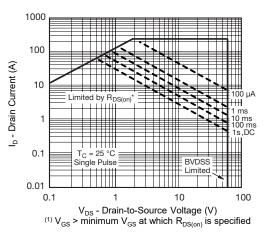


Source-Drain Diode Forward Voltage

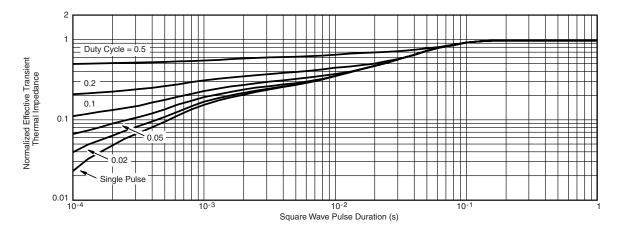
#### THERMAL RATINGS



Max. Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

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